

# HD151015

# 9 bit Level Shifter/Transceiver With 3 State Outputs

REJ03D0300-0500 Rev.5.00 May 10, 2006

## **Description**

The HD151015 is an IC which consists of 9 bus transceivers (three state output) in a 24 pin package. Signals are transmitter from A to B when the direction control input (DiR) is at a high level, and from B to A when DiR is at a low level. When the enable input  $(\overline{G})$  is high, A and B are isolated. And this product has two terminals  $(V_{CCA}, V_{CCB})$ ,  $V_{CCA}$  is connected with control input and A bus side,  $V_{CCB}$  is connected with B bus side.  $V_{CCA}$  and  $V_{CCB}$  are isolated. Consequently, it is best to change the level in case of two supply voltage coexist on one board and application of power management.

#### **Features**

- This product function as level shift transceiver that change V<sub>CCA</sub> input level to V<sub>CCB</sub> output level, V<sub>CCB</sub> input level to V<sub>CCA</sub> output level by providing different supply voltages to V<sub>CCA</sub> and V<sub>CCB</sub>.
- This product is able to the power management: Turn on and off the supply on  $V_{CCB}$  side with providing the supply of  $V_{CCA}$ .

(Enable input  $(\overline{G})$ : High level)

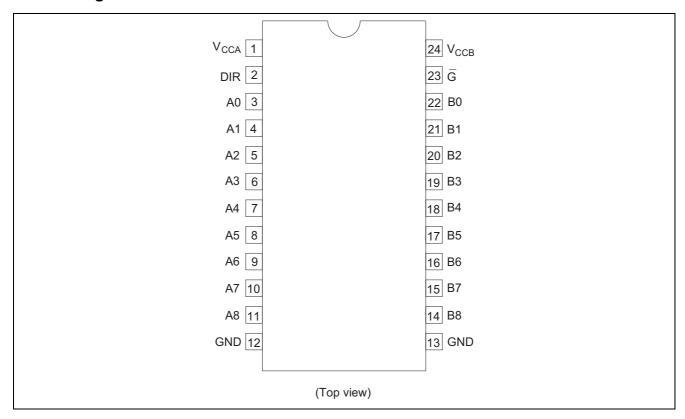
- Inputs and outputs are CMOS level, and the power dissipation is the same as CMOS standard logic.
- Wide operating supply voltage range:

 $V_{CCA} = V_{CCB} = 2 \text{ to } 6 \text{ V } (V_{CCB} \ge V_{CCA} - 0.5 \text{ V})$ 

- Wide operating temperature range: Ta = -40 to  $85^{\circ}C$
- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)	
HD151015TEL	TSSOP-24 pin	PTSP0024JB-A (TTP-24DBV)	Т	EL (1,000 pcs/reel)	

## **Pin Arrangement**



## **Function Table**

Inputs			
G	DIR	Outputs	
L	L	B data to A bus	
L	Н	A data to B bus	
Н	Х	Z	

H : High levelL : Low levelZ : High ImpedanceX : Immaterial

# **Absolute Maximum Ratings**

Item	Symbol	Rating	Unit	Conditions
Supply Voltage	V <sub>CCA</sub> , V <sub>CCB</sub>	-0.5 to +7.0	V	
Input Diode Current	I <sub>IK</sub>	-20	mA	V <sub>I</sub> = -0.5
		20	mA	$V_{I} = V_{CC} + 0.5$
Input Voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V	
Output Diode Current	I <sub>OK</sub>	-50	mA	V <sub>O</sub> = -0.5
		50	mA	$V_{\rm O} = V_{\rm CC} + 0.5$
Output Voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V	
Output Current	I <sub>O</sub>	±50	mA	
VCC or Ground Current	I <sub>CC</sub> or I <sub>GND</sub>	±50	mA	per output pin
Storage Temperature	Tstg	-65 to + 150	°C	

Note: 1. The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

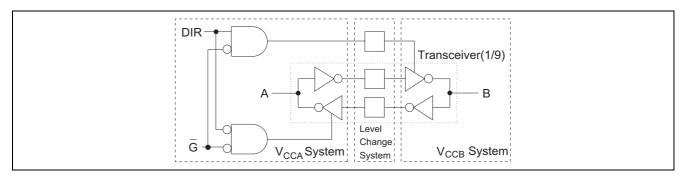
# **Recommended Operating Conditions**

Item	Symbol	Rating	Unit	Conditions
Supply voltage	V <sub>CCA, B</sub>	2.0 to 6.0	V	$V_{CCB} \ge V_{CCA} - 0.5 \text{ V}$
Input voltage	$V_{IN}$	0 to V <sub>CC</sub>	V	
Output voltage	$V_{\text{OUT}}$	0 to V <sub>CC</sub>	V	
Operating Temperature	T <sub>A</sub>	-40 to +85	°C	
Input Rise and Fall Time*1	t <sub>r</sub> , t <sub>f</sub>	8	ns/V	V <sub>CC</sub> @3.0 V (Input DiR, G, A)
				V <sub>CC</sub> @4.5 V (Input B)
				V <sub>CC</sub> @5.5 V (Input B)

Note: 1. The item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

# **Logick Diagram**



### **Electrical Characteristics**

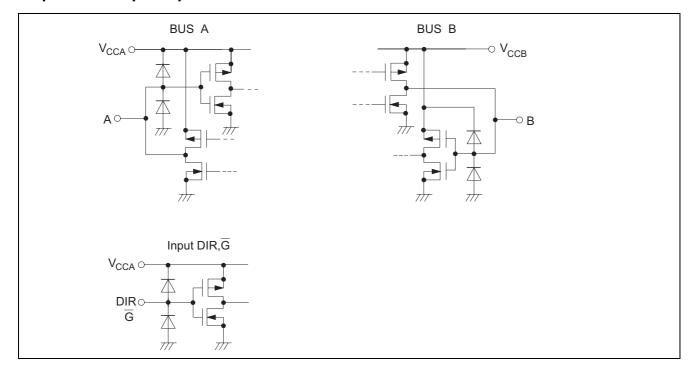
	Sym-	V <sub>CCA</sub>	V <sub>CCB</sub>	1	Га = 25°	°C		-40 to °C				
Item	bol	(V)	(V)	Min	Тур	Max	Min	Max	Unit	Conditions		
Input Voltage	$V_{\text{IH}}$	3.0	3.0	2.1	1.5	_	2.1	_	V	V <sub>OUT</sub> = 0.1 V or V <sub>CC</sub> – 0.1 V		
		4.5	4.5	3.15	2.25	_	3.15	_				
		5.5	5.5	3.85	2.75	_	3.85	_				
	$V_{IL}$	3.0	3.0	_	1.5	0.9		0.9	V	$V_{OUT} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$		
		4.5	4.5	_	2.25	1.35		1.35				
		5.5	5.5	_	2.75	1.65	_	1.65				
Output	V <sub>OH</sub>	2.7	4.5	2.6	2.69	_	2.6	_	V	$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OH} = -50 \mu A$		A* <sup>1</sup>
Voltage		2.7	4.5	4.4	4.49	_	4.4	_		$V_{IN} = V_{IL} \text{ or } V_{I}$	<sub>H</sub> , I <sub>OH</sub> = –50 μA	В
		2.7	4.5	2.3	_	_	2.2	_	V	V <sub>IN</sub> =	I <sub>OH</sub> = -4 mA	Α
		2.7	4.5	3.9	_	_	3.8	_		$V_{IL}$ or $V_{IH}$	I <sub>OH</sub> = -12 mA	В
	$V_{OL}$	2.7	4.5	_	0.001	0.1	_	0.1	V	$V_{IN} = V_{IL} \text{ or } V_{I}$	<sub>H</sub> , I <sub>OL</sub> = 50 μA	A.B
		2.7	4.5	_	_	0.32	_	0.37	V	$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OL} = 12$ mA A.B		A.B
Input Current	I <sub>IN</sub>	3.3	5.5	_	_	±0.1		±1.0	μΑ	V <sub>IN</sub> = V <sub>CC</sub> or GND		
Off State	loz	3.3	5.5	_	_	±0.5	_	±5.0	μΑ	$V_{IN}(\overline{G}) = V_{IH}, V_{IN} = V_{CC} \text{ or GND},$		
Output										$V_{OUT} = V_{CC}$ or GND		
Current												
Supply	I <sub>CCA.B</sub>	3.3	5.5	_	_	8.0	_	80	μΑ	$V_{IN} = V_{CC}$ or GND		
Current	$I_{CCA}$	5.5	0		_	8.0		80	μΑ	V <sub>IN</sub> = V <sub>CC</sub> or GND, B Input OPEN		

Note: 1. A: Output A, B: Output B, A.B: Output A.B

# **Switching Characteristics**

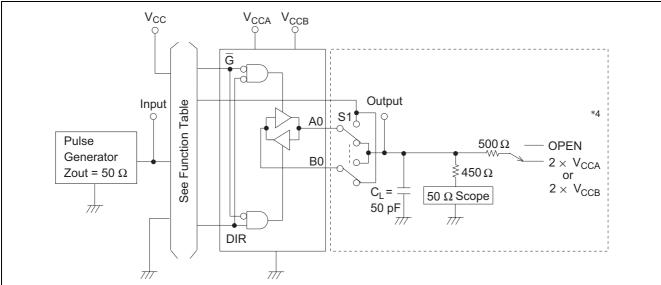
		Ta = 25°C			Ta = -40 to 85°C			
		$V_{CCA} = 3.0 \text{ V}, V_{CCB} = 5.0 \text{ V}$			$V_{CC} = 2.7 \text{ V}$	, $V_{CCB} = 4.5 \text{ V}$		
Item	Symbol	Min	Тур	Max	Min	Max	Unit	Conditions
Propagation Delay Time	t <sub>PLH</sub>	1.0	5.0	10.0	1.0	12.0	ns	$B\toA$
		1.0	5.0	10.0	1.0	12.0		$A \to B$
	t <sub>PHL</sub>	1.0	5.0	10.0	1.0	12.0	ns	$B\toA$
		1.0	5.0	10.0	1.0	12.0		$A \to B$
Output Enable Time	$t_{ZH}$	1.0	8.0	16.0	1.0	20.0	ns	$\overline{G} \to A$
		1.0	8.0	16.0	1.0	20.0		$\overline{G} \to B$
	$t_{ZL}$	1.0	9.0	16.0	1.0	20.0	ns	$\overline{G} \to A$
		1.0	9.0	16.0	1.0	20.0		$\overline{G} \to A$
Output Disable Time	t <sub>HZ</sub>	1.0	9.0	16.0	1.0	20.0	ns	$\overline{G} \to A$
		1.0	9.0	16.0	1.0	20.0		$\overline{G} \to B$
	$t_{LZ}$	1.0	8.0	16.0	1.0	20.0	ns	$\overline{G} \to A$
		1.0	8.0	16.0	1.0	20.0		$\overline{G} \to B$

# Input and Output Equivalent Circuit



# **Switching Time Test Method**

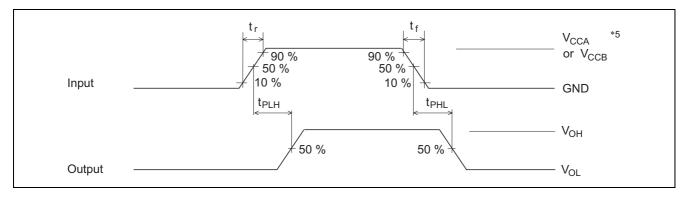
### **Test Circuit**



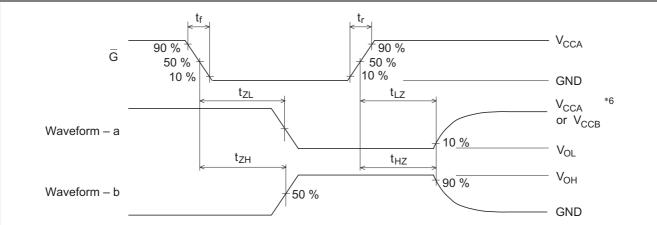
Notes:

- 1.  $C_L$  includes probe and jig capacitance.
- 2. A1-B1, A2-B2, A3-B3, A4-B4, A5-B5, A6-B6, A7-B7, A8-B8 are identical to above circuit.
- 3. S1 is a input/output switch.
- 4. When A  $\rightarrow$  B:  $2\times V_{\text{CCB}},\, B \rightarrow$  A:  $2\times V_{\text{CCA}}$

### Waveforms-1



#### Waveforms-2

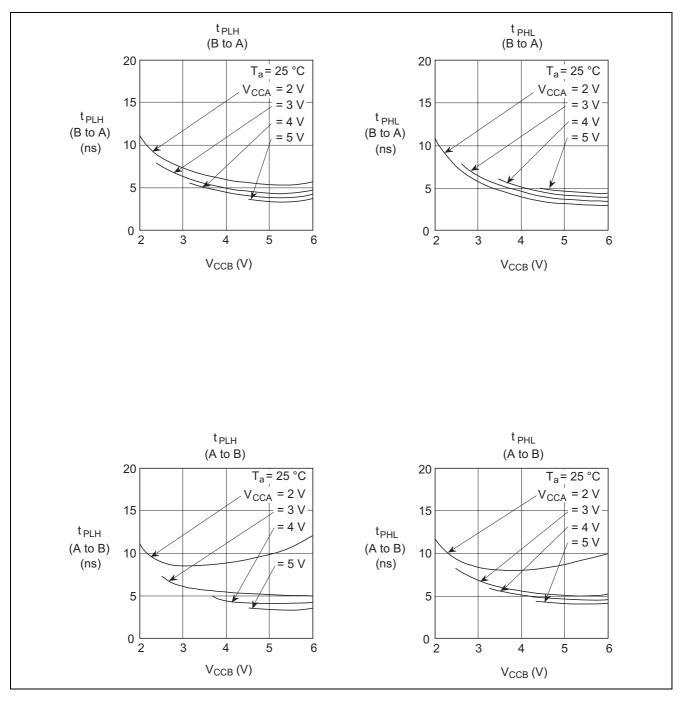


Notes:

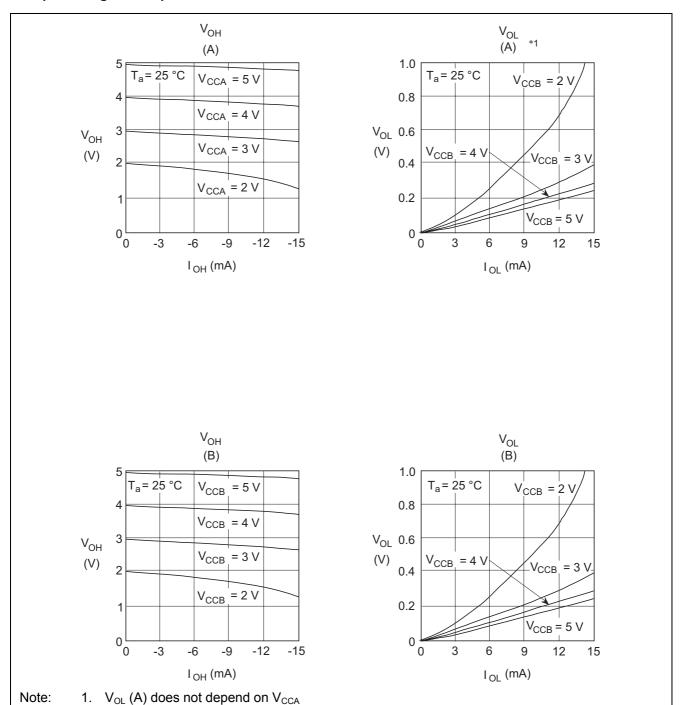
- 1.  $t_r = t_f = 2.5 \text{ ns.}$
- 2. Input Waveform: PRR = 1 MHz, duty cycle 50%
- 3. Waveform-a is set as outputs are "Low" when enable input is "Low".
- 4. Waveform-b is set as outputs are "High" when enable input is "Low".
- 5. When A  $\rightarrow$  B:  $V_{CCA}$ , B  $\rightarrow$  A :  $V_{CCB}$
- 6. When  $\overline{G} \to A$ :  $V_{CCA}$ ,  $\overline{G} \to B$ :  $V_{CCB}$

# **Typical Characteristic Curves**

## Propagation Delay Times vs Power Supply $(V_{CCA}, V_{CCB})$

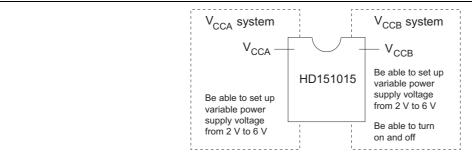


### **Output Voltage vs Output Current**



### **Application**

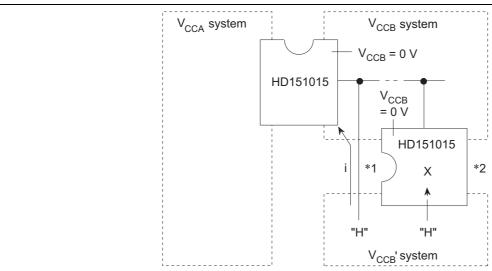
### For power management system (1)



Note: HD151015 is also used for power management system. We show some Examples.

- 1. For V<sub>CCA</sub> side
  - Be able to switch fast mode ( $V_{CCA} = 5 \text{ V}$ ) and power save mode ( $V_{CCA} = 3 \text{ V}$ )
- 2. For V<sub>CCB</sub> side
  - Be able to switch normal mode ( $V_{CCB} = 5 \text{ V}$ ) and suspend mode ( $V_{CCB} = 0 \text{ V}$ )
- 3. For both side
  - Be able to switch fast mode ( $V_{CCA}$  = 5 V) and power save mode ( $V_{CCA}$  = 3 V) (When  $V_{CCA}$  =  $V_{CCB}$ , in this case, please switch  $V_{CCA}$  and  $V_{CCB}$  simulteneously.)

#### For power management system (2) (Common bus line in different power system)



HD151015 uses conventional CMOS input circuit. So, you have to care of designing in case of common bus line in different power block. We show one example.

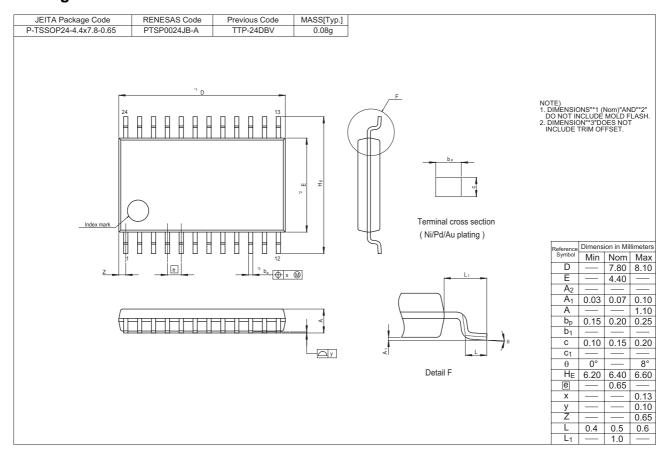
In this case, if  $V_{CCB}$  become turn off, current flows from bus line to  $V_{CCB}$ . (refer to  $*^1$ )

This is cause of malfunction. In order to prevent this problem, I recommend using this device for interface to each power block. (refer to  $*^2$ )

#### [Cautions on using]

Please use this IC on condition of  $V_{CCA}$  usually ON, because if you use it on condition of  $V_{CCA}$  being OFF,  $V_{CCB}$  being ON, it will be troubled.

## **Package Dimensions**



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